

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	10	"bond breaking energy"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 09:59
L2	928	"bond breaking"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 09:59
L3	1315	(438/458,460,463).CCLS.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 09:59
L4	1126	L3 and @ad<"20030828"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 09:59
L5	2	2 and 4	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 09:59
S1	8	US-639174B1-\$.DID. OR US-6159824-\$.DID. OR US-633555B1-\$.DID. OR US-6159825-\$.DID. OR US-633526B1-\$.DID. OR US-624864B1-\$.DID. OR US-630995B1-\$.DID. OR US-629481B1-\$.DID. OR US-629131B1-\$.DID. OR US-629131B1-\$.DID. OR US-629080B1-\$.DID. OR US-6309950-\$.DID. OR US-6335264-\$.DID. OR US-6335559-\$.DID. OR US-6391740-\$.DID. OR US-6455342-\$.DID. OR US-6458672-\$.DID.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:26
S2	5	((("6248649") or ("6294814") or ("6291314") or ("6291313") or ("6290804"))).PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:28
S3	13	S1 S2	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:40
S4	19	(shasheen-mohamad-a liu-mark-y taylor-mitchell-c).in.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:36
S5	1315	(438/458,460,463).CCLS.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:35
S6	1126	S5 and @ad<"20030828"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 09:59

S7	20761	SiGe "silicon germanium"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:26
S8	1934	laser with (dicing cleaving)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:26
S9	297120	infrared IR	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:36
S10	18	S7 and S8 and S9	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:38
S11	70	S7 and S8	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:38
S12	62	S11 and @ad<"20030828"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:38
S13	42	S12 and ("438"/\$3 "257"/\$3).ccls.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:25
S14	13	S3 and laser	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/17 15:40
S15	629611	void cavity bubble	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/02/18 08:26
S16	1934	laser with (dicing cleaving)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:26
S17	902	S15 and S16	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:26
S18	20761	SiGe "silicon germanium"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:26
S19	46	S17 and S18	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:26
S20	1315	(438/458,460,463).CCLS.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:28
S21	1126	S20 and @ad<"20030828"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:28
S22	347	S21 and S15	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:29

S23	179	S22 and laser	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/02/18 08:29
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(FILE 'HOME' ENTERED AT 10:00:39 ON 18 FEB 2005)

FILE 'INSPEC, CAPLUS' ENTERED AT 10:00:48 ON 18 FEB 2005

L1 878718 S LASER
L2 1787 S WAFER (S) (DICE OR DICING OR CLEAVE OR CLEAVING)
L3 208 S L1 AND L2
L4 5928 S BOND BREAKING
L5 0 S L4 AND L3
L6 7 S L3 AND BOND

FILE 'STNGUIDE' ENTERED AT 10:02:16 ON 18 FEB 2005

L7 0 S L3 AND SIGE

FILE 'INSPEC, CAPLUS' ENTERED AT 10:03:54 ON 18 FEB 2005

L8 0 S L3 AND SIGE